

Name:

Roll no.:

Test No.:

Subject: Full test 1

1. (a) Nanomaterials can be defined as the materials possessing at minimum, one external dimension measuring 1-100 nm. They can occur naturally or as a product of a reaction or be produced purposefully ~~through~~ through some synthesis techniques. These materials have different physical and chemical properties to make them more useful.

There are two main approaches ~~of~~ for nanomaterial synthesis

- (i) Top down: Size reduction from bulk materials
- (ii) Bottom up: material synthesis from atomic level.

Some common techniques are,

(i) Inert Gas Condensation:

- produces well defined grains with a narrow size distribution.
- involves two steps, first is the evaporation of material and controlled condensation of evaporated atoms to produce desired particle size. Evaporation is done inside a chamber filled with inert gas like helium.

(ii) Chemical Vapour deposition:

Silicon atoms reaching the substrate are produced by chemical reaction between SiCl_4 & hydrogen.

(iii) Sputtering

- physical vapour decomposition process
- high energy ions bombarded on a solid target to eject its atoms in vapour phase.

- sputtered atoms can be deposited in form of nano film on Cold Substrate
- low deposition time and low temperature of substrate helps in preventing growth of nano particles into large ones.

(iv) Electro deposition

- it is a single step method
- Large number of nanocrystalline structures have been made by this method.

1.(b) $\vec{P} = \frac{2}{\rho^2} \hat{a}_\rho \quad nC/m^2$

$$d\vec{P} = \epsilon_0 \chi dE$$

inside the conductor $[0 < r < a]$

as $\rho = 0$ Here, $\therefore [E = 0 \Rightarrow D = 0]$

in a region $[a < r < b]$

$$dE = \frac{1}{\epsilon_0 \chi} \left(\frac{-4}{\rho^3} \right) \cdot d\rho \cdot \hat{a}_\rho$$

Integrating both sides.

$$\int dE = \frac{1}{\epsilon_0 \chi} \int_a^b \frac{-4}{\rho^3} \cdot d\rho \cdot \hat{a}_\rho = \frac{1}{\epsilon_0 \chi} \left[\frac{-4}{\rho^2} (-2) \right]_a^b$$

$$\vec{E} = \frac{4}{\epsilon_0 \chi} \cdot \left[\frac{1}{b^2} - \frac{1}{a^2} \right] \hat{a}_\rho$$

$$\vec{E} = \frac{2}{8.854 \times 10^{-12} (11.7-1)} \times \left[\frac{1}{(5 \times 10^{-1})^2} - \frac{1}{(10^{-1})^2} \right] \hat{a}_\rho$$

$$\boxed{\vec{E} = -2.11 \times 10^7 \hat{a}_\rho \text{ V/m}}$$

$$\vec{D} = \epsilon_0 \epsilon_r \vec{E} = 8.854 \times 10^{-12} \times 11.7 (-2.11 \times 10^7)$$

$$\boxed{\vec{D} = -2.185 \times 10^{-3} \hat{a}_\rho \text{ C/m}^2}$$

for $a > b$

$$\vec{E} = \frac{1}{\epsilon_0 \epsilon_r} \int_b^\infty -\frac{4}{\rho^3} \cdot d\rho \quad \hat{a}_\rho = \frac{1}{\epsilon_0 \epsilon_r} \left[\frac{-4}{(-21 \rho^2)} \right]_b^\infty$$

$$\vec{E} = \frac{2}{8.854 \times 10^{-12} (11.7-1)} \left[\frac{1}{a^2} - \frac{1}{b^2} \right] \hat{a}_\rho$$

$$\boxed{\vec{E} = 21.11 \left[\frac{1}{a^2} - 40000 \right] \hat{a}_\rho \text{ V/m}}$$

$$\vec{D} = \epsilon_0 \epsilon_r \vec{E} = 8.854 \times 12.7 \times 10^{-12} \times 21.11 \left[\frac{1}{a^2} - 40000 \right] \hat{a}_\rho$$

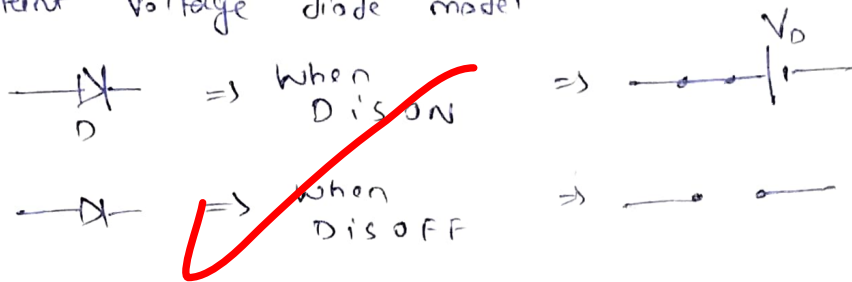
$$\boxed{\vec{D} = 2.373 \times 10^{-9} \left[\frac{1}{a^2} - 40000 \right] \hat{a}_\rho \text{ C/m}^2}$$

$$V_{ab} = - \int_b^a \vec{E} \cdot d\rho = - \int_{5 \times 10^{-3}}^{7 \times 10^{-3}} (-2.11 \times 10^7) \cdot d\rho$$

$$\boxed{V_{ab} = -84.4 \text{ K V}}$$

(11)

Constant Voltage diode model



Assuming Diode is OFF

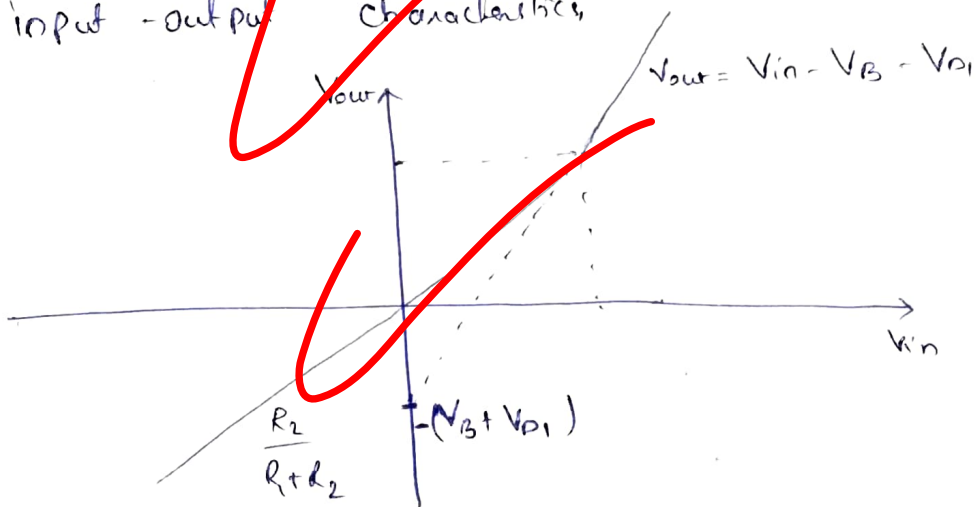


$$V_{out} = \frac{R_2}{R_1 + R_2} \cdot V_{in}$$

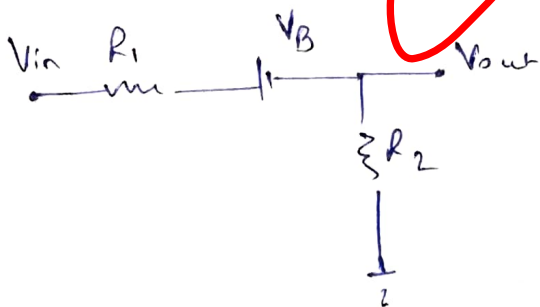
So, when $V_{out} > V_{in} - V_B - V_{D1}$
 Diode will turn ON $\Rightarrow$ i.e., $V_{in} > V_B + V_{D1}$

Hence output $\Rightarrow V_{out} = V_{in} - V_B - V_{D1}$

input-output characteristics

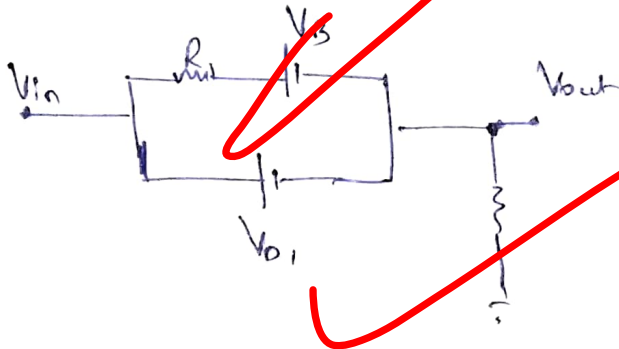


When $D_1 \rightarrow$ is OFF



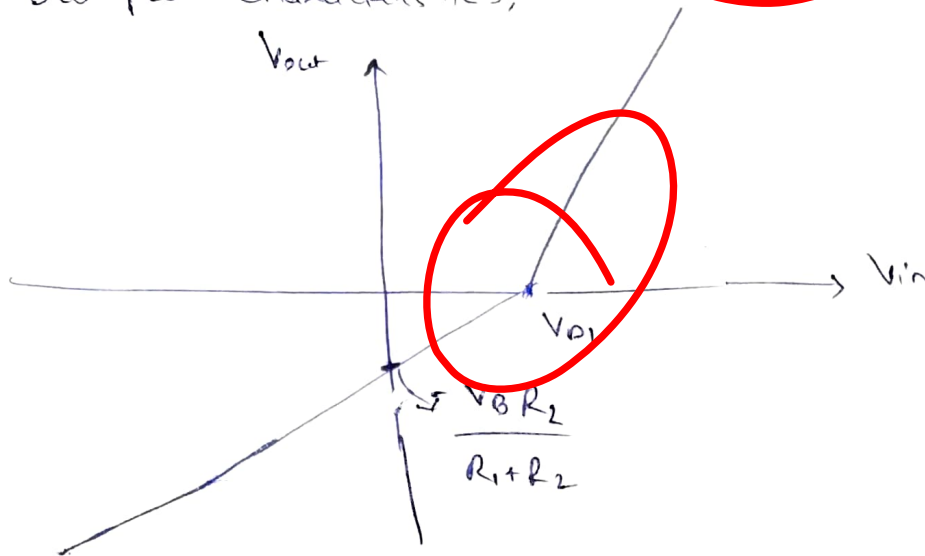
$$V_{out} = \left(\frac{V_{in} - V_B}{R_1 + R_2} \right) \times R_2$$

and when ~~Diode is ON~~ Diode is ON, i.e., ($V_{in} > V_{D1}$)

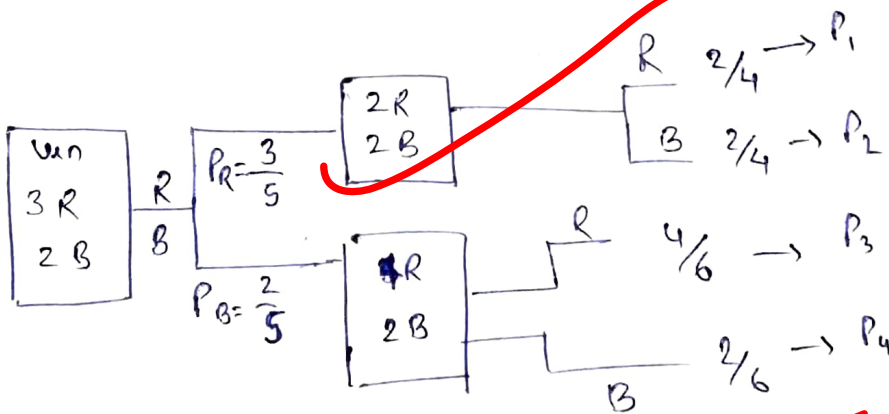


$$V_{out} = V_{in} - V_{D1}$$

Input out put characteristics,



(d)



(i)

$P(\text{both balls drawn are red}) = \frac{3}{5} \times \frac{2}{4} = \frac{3}{10} \text{ Ans.}$

(ii)

$P(\text{2nd balls is red then 1st ball was blue}) \rightarrow$ using Bayes's theorem

P.E P =

$$P = \frac{P_3 \times P_8}{P_3 \times P_8 + P_1 \times P_2} = \frac{\frac{4}{6} \times \frac{2}{5}}{\frac{4}{6} \times \frac{2}{5} + \frac{2}{4} \times \frac{3}{5}} = \frac{\frac{4}{15}}{\frac{4}{15} + \frac{3}{10}} = \frac{4}{15} \times \frac{30}{17}$$

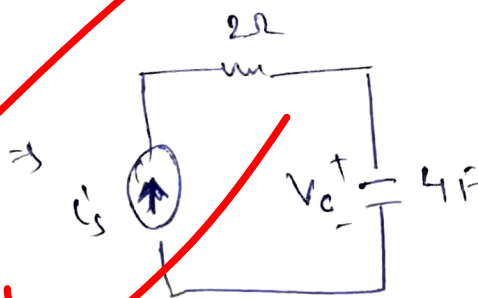
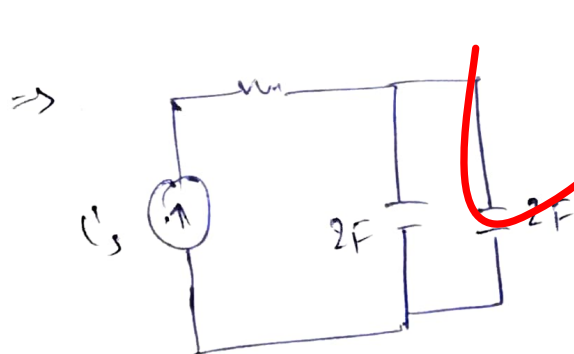
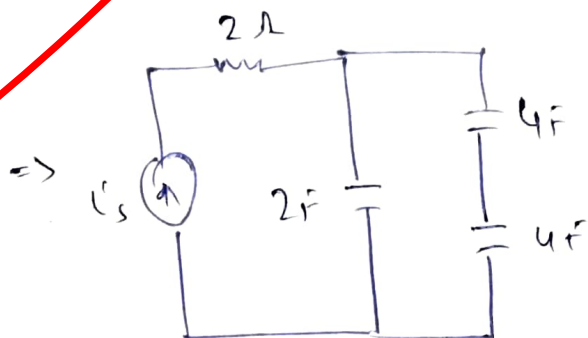
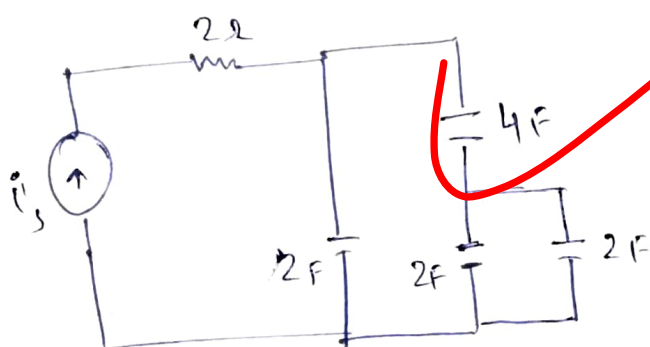
$$P = \frac{8}{17} \text{ Ans.}$$

1. (2)

In Series Combination $\frac{1}{C_{eq}} = \frac{1}{C_a} + \frac{1}{C_b} + \frac{1}{C_c}$

In parallel Combination $C_{eq} = C_a + C_b + C_c$

Using this and Redrawing the circuit

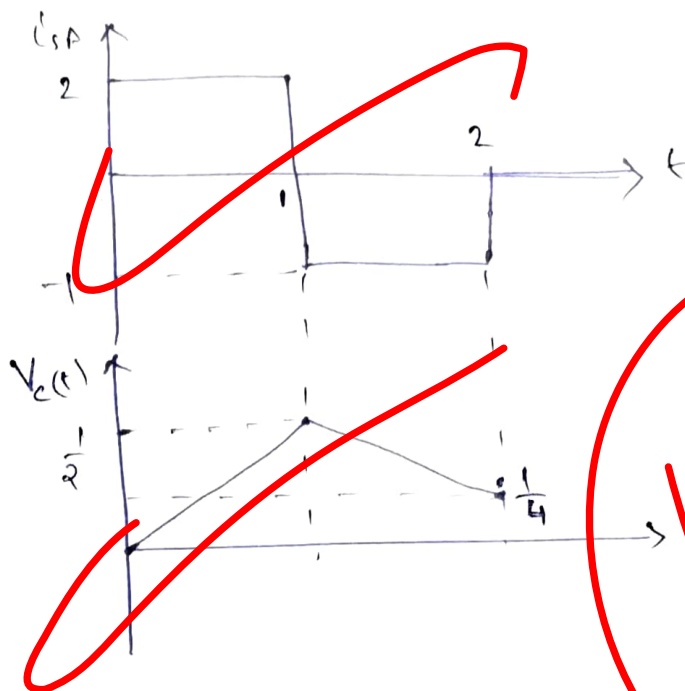


$$C_{eq} = 4F$$

As $i_c = C \frac{dv}{dt}$ & $V_c = \frac{1}{C} \int i_c dt$

Hence, $V_c(t) = \frac{1}{C_{eq}} \int i_c dt = \frac{1}{4} \int i_s dt$

~~$= \frac{1}{4} \left[\int_0^1 2 dt + \int_1^2 (-1) dt \right]$~~



(ii) Energy dissipated in 2Ω resistor

$E = \int_0^2 i_s^2 \times R dt$

$= \int_0^1 (2)^2 \times 2 dt + \int_1^2 (-1)^2 \times 2 dt$

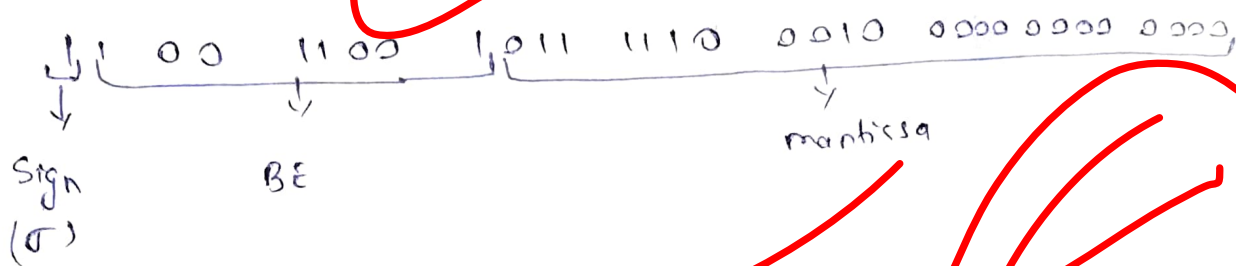
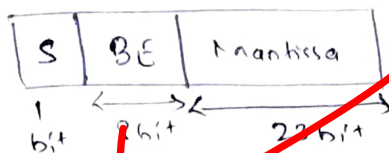
$= 8 [t]_0^1 + 2 [t]_1^2$

$= (8-0) + 2(2-1)$

$E = 10 \text{ J}$

4.6(i)

Single precision form



Here Sign (S) bit is 1 $\Rightarrow$ Hence it is a negative number.

BE = 193, ~~Actual~~ Actual Exponent (AE) = BE - Bias

Bias = $2^{8-1} - 1 = 127$

~~Actual~~ AE = e = 193 - 127 = 26

~~Mantissa(x) = 0111~~

Mantissa(x) = 1.011 1110 0010 0000 0000 0000

Shifting towards left by 11 bit
 $= (1011 1110 0010) \times 2^{-11}$
 $= (3042) \times 2^{-11}$

Decimal Representation $\sigma(\bar{x}) 2^e$

$- [3042] \times 2^{-11} \times 2^{26}$

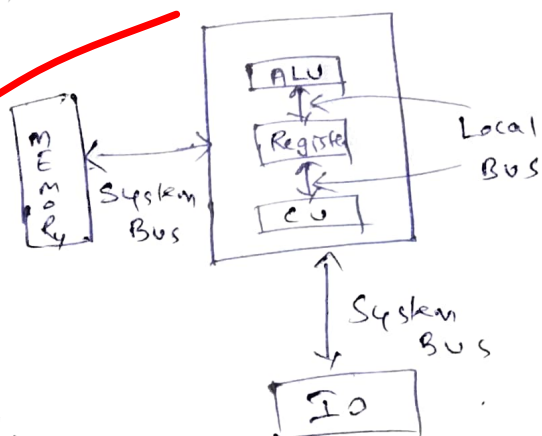
Ans $\rightarrow - (3042) \times 2^{15}$

4(a)
(ii)

In Computer System the ~~Basic~~ Processing System is a major block which is responsible for performing and controlling the tasks by giving them appropriate signals.

Basic Processing System in a Computer consists of 3 units

- (i) Arithmetic Logical Unit (ALU)
- (ii) Control Unit (CU)
- (iii) Registers.



Arithmetic Logical Unit (ALU)

It performs all the mathematical and logical operations need to be performed for completion of task

Such addition, subtraction, multiplication, division, AND, OR, XOR operations etc, increment decrement, shifting operation with the help of accumulator Register.

Control unit (CU)

It is responsible for generating control signals to fetch, read, write data to or from memory or I/O device. It is like brain of processing unit and controls the flow of data in the Computer System.

Registers → They are used for storage of data for temporarily purpose so that ALU operation can be performed on the data and then with the help of CU it is send to destination.

4.(b)
(ii)

Phantom loading → It is the fictitious loading for testing the performance of appliance (consumers) without actually loading to normal condition.

Advantages

→ The losses will be lesser during this loading compared to actual loading

→ Hence low cost will be there for testing

4.(b)(ii)

$$K = 600 \text{ rev/kwh}$$

Date to lag adjustment $\Delta = 86^\circ$

Then,

With lag adjustment, $\Delta = 90^\circ$,

$$P = V I \cos \phi = 240 \times 10 \times 0.8 = 1920 \text{ W} = 1.92 \text{ KW}$$

~~for 1 hr, $P(\text{Kwh}) = 1.92 \text{ Kwh}$~~

$$\text{Hence, } \text{rev/hr} = 600 \times 1.92 = 1152$$

$$\text{Speed in rpm} = \frac{1152}{60} = 19.2 \text{ rpm}$$

Now with lagged adjustment $\Delta = 86^\circ$

(1)

$$P_m = VI \sin(\Delta\phi)$$

$$P_m = 240 \times 10 \sin(86 - 0) = 2394 \text{ W} \quad [\text{UPF} \Rightarrow \phi = 0]$$

$$\approx 2.4 \text{ kW} = 2.394 \text{ kW}$$

$$P_T = VI \times \cos\phi = 240 \times 10 \times 1 = 2400 \text{ kW}$$

$$\% \text{ error} = \frac{P_m - P_T}{P_T} \times 100 = \frac{2.394 - 2.4}{2.4} \times 100$$

$$\boxed{\% \text{ error} = -0.25\%}$$

(2)

$$P_m = 240 \times 10 (\sin[86 - (\cos^{-1} 0.5)]) = 1.052 \text{ kW}$$

$$P_T = 240 \times 10 \times 0.5 = 1.2 \text{ kW}$$

$$\% \text{ error} = \frac{1.052 - 1.2}{1.2} \times 100$$

$$\boxed{\% \text{ error} = -12.33\%}$$

1(b) (iii)
(100)
1.

$$I_1 = 100 \pm 2 \text{ A} \Rightarrow \epsilon_1 = 2\%$$

$$I_2 = 200 \pm 5 \text{ A} \Rightarrow \epsilon_2 = 2.5\%$$

Error

$$\% \epsilon_x = \left[\frac{I_1}{I_1 + I_2} \times \epsilon_1 + \frac{I_2}{I_1 + I_2} \times \epsilon_2 \right]$$

$$= \left[\frac{100}{100 + 200} \times 2 + \frac{200}{100 + 200} \times 2.5 \right] = \frac{7}{3} \%$$

$$I = I_1 + I_2 = 100 + 200 = 300$$

$$\frac{7}{3} \% \text{ of } I = \frac{7}{3} \times \frac{300}{100} = 7 \text{ A}$$

$$\therefore \boxed{I = (300 \pm 7) \text{ A}}$$

$$\left(\frac{\partial I}{\partial I_1} = \frac{\partial I}{\partial I_2} = 1 \right)$$

(2).

As standard deviations,

$$\sigma_1 = 2 \text{ A}, \quad \sigma_2 = 5$$

$$\sigma_x = \sqrt{\left(\frac{\partial I}{\partial I_1} \right)^2 \sigma_1^2 + \left(\frac{\partial I}{\partial I_2} \right)^2 \sigma_2^2}$$

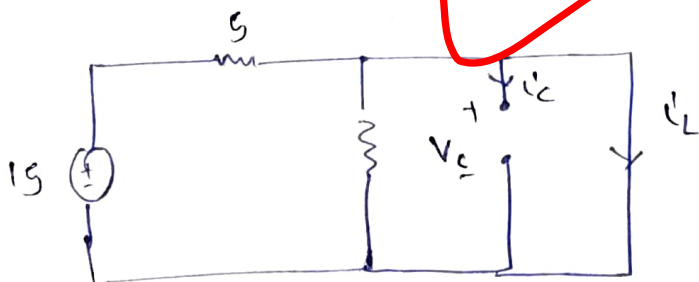
$$= \sqrt{(1)^2 \times (2)^2 + (1)^2 \times (5)^2}$$

$$\sigma_x = 5.385$$

$$\boxed{I = (300 \pm 5.385) \text{ A}}$$

A.C.
(i)

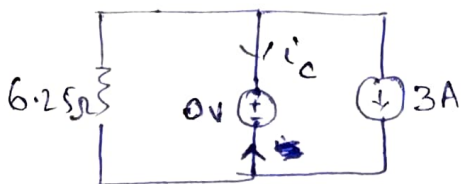
For $t < 0$, Circuit has achieved steady state
Hence Capacitor behaves as open circuit
and inductor behaves as short circuit



$$i_L(0^-) = \frac{15}{5} = 3 \text{ A}$$

$$V_C(0^-) = 0 \text{ V}$$

For $t \geq 0^+$



As inductor does not allow sudden change in current hence behaves as current source. Similarly, Capacitor does not allow sudden change in voltage hence taken as voltage source.

$$1. \boxed{V_c(0^+) = 0 \text{ V}}$$

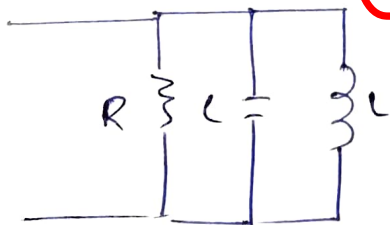
$$2. \boxed{i_c'(0^+) = -i_L'(0^+) = -3 \text{ A}}$$

as, $i_c' = C \frac{dV}{dt} \Rightarrow i_c'(0^+) = C \frac{dV_c(0^+)}{dt}$

$$\left. \frac{dV_c}{dt} \right|_{t=0^+} = \frac{i_c'(0^+)}{C} = \frac{-3}{10 \times 10^{-3}}$$

$$\boxed{\left. \frac{dV_c(t)}{dt} \right|_{t=0^+} = -300 \text{ V/sec.}}$$

Q1) for $t > 0$ circuit is



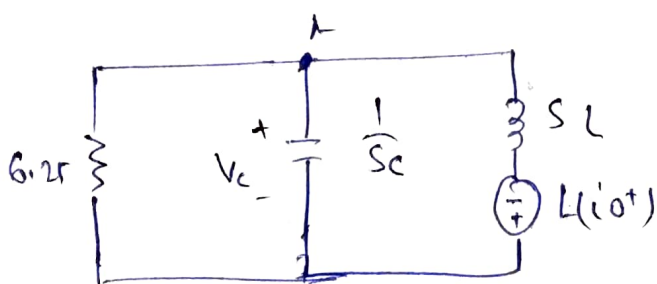
$$R^2 = (6.25)^2 = 39.0625$$

$$4 \frac{C}{L} = \frac{4 \times 10 \times 10^{-3}}{1} = \frac{1}{25}$$

$$\text{As, } \frac{1}{R^2} < 4 \frac{C}{L}$$

Hence, circuit is Underdamped

Q2) for $t > 0$, in Laplace domain



$$L(i0^+) = 1 \times 3 = 3 \text{ V}$$

KCL at C,

$$\frac{V_c}{6.25} + V_c sC + \frac{(V_c + 3)}{s} = 0$$

$$V_c \left[\frac{1}{6.25} + \frac{sC}{100} + \frac{1}{s} \right] = -\frac{3}{s}$$

$$V_c \left(\frac{16s + s^2 + 120}{100s} \right) = - \frac{3}{s}$$

$$V_c = - \frac{300}{s^2 + 16s + 120} = - \left[\frac{3}{(s+8)^2 + 6^2} \right] \times \frac{6}{6}$$

* Taking inverse Laplace,

$$V_c(t) = - \frac{1}{2} e^{-8t} \sin 6t \times 120$$

$$V_c(t) = -50 e^{-8t} \sin 6t \text{ Volts.}$$



5. (a)
(i)

Cache memory is an extra memory which is used to store the image of ^{some} data present in main memory and secondary memory so that it can be accessed faster by CPU when needed, and there will be no need to access the main memory which may take longer time.

Advantages

- It makes the CPU works faster as its access time is much lesser than main and secondary memory and hence CPU utilization is better.
- It stores program that can be used executed in a short period of time.

(ii)

Access time with miss

$$= (\text{Instruction}) \times \left\{ \left(\text{instruction miss rate} \right) [CPI + \text{miss penalty}] \right.$$

$$\left. + \left(1 - \text{instruction miss rate} \right) [CPI] \right\}$$

$$+ (\text{Data}) \times \left\{ \text{Data miss rate} (CPI + \text{miss penalty}) \right.$$

$$\left. + \left(1 - \text{Data miss rate} \right) CPI \right\}$$

$$= 0.36 \times \left\{ \frac{2}{100} \times (2 + 40) + \left(1 - \frac{2}{100} \right) \times 2 \right\}$$

$$+ (1 - 0.36) \left\{ \frac{4}{100} \times (2 + 40) + \left(1 - \frac{4}{100} \right) \times 2 \right\}$$

$$= 1.208 + 2.304 = 3.312 \text{ cycles / inst}$$

Without a miss

$$CPI = 2 \text{ cycles}$$

Hence,

machine will run $(3.312 - 2) = 1.312$ cycles faster with Perfect Cache without a miss.

5.(b)

For A, $(x, y, z) = (\frac{K}{2}, \infty, \frac{L}{2}, \infty)$

Taking Reciprocal for miller indices,

$$(h, K, l) = (0, \frac{2}{1}, 0) \quad \left[\frac{1}{\infty} = 0 \right]$$

∴ For A, multiplying by L
miller indices

$$(h, K, l) = (0, 2, 0)$$

For B interceptions

$$(x, y, z) = (L, \frac{L}{2}, \frac{L}{2})$$

Taking Reciprocals

$$= \left(\frac{1}{L}, \frac{2}{L}, \frac{2}{L} \right)$$

hence, miller indices for B

$$(h, K, l) = (1, 2, 2)$$

5.(c)

$$\phi = 50^\circ$$

$$\beta = \tan^{-1} \left(\frac{\omega L}{R} \right) = \tan^{-1} \left(\frac{2\pi \times 30 \times 120 \times 10^{-3}}{362} \right) = 4.96^\circ$$

$$\theta_p = -45^\circ = -0.79^\circ$$

$$\theta_c = 90^\circ = 1.5^\circ$$

$$\sigma_p = \frac{0.8}{120}$$

$$\sigma_c = -\frac{0.2}{120}$$

$$CT \text{ Ratio} = \frac{20}{1}$$

$$PT \text{ Ratio} = \frac{120}{1}$$

$\alpha/2$ Here,

$$\phi = \alpha + \beta + \theta_c + \theta_p$$

$$50^\circ = \alpha + 4.96 + 1.5 + 0.75 \Rightarrow \alpha = 42.79^\circ$$

$$P_{True} = \frac{CT \text{ Ratio}}{1 + \sigma_c} \times \frac{PT \text{ Ratio}}{1 + \sigma_p} \times \text{Wattmeter Reading} \times \frac{\cos \phi}{\cos \beta \cdot \cos \alpha}$$

$$= \frac{20}{\left[1 + \left(-\frac{0.2}{120} \right) \right]} \times \frac{120}{\left[1 + \left(\frac{0.8}{120} \right) \right]} \times 350 \times \frac{\cos 50}{\cos 4.96 \times \cos 42.79}$$

$$P_{True} = 611.785 \text{ KW}$$

5. (i), For eigen value, forming characteristic Equation

$$(C - \lambda I) = 0 \Rightarrow \begin{vmatrix} \lambda & 0 & 0 & 1 \\ 1 & -\lambda & 0 & 0 \\ 0 & 1 & -\lambda & 0 \\ 0 & 0 & 1 & -\lambda \end{vmatrix} = 0$$

$$\Rightarrow \begin{vmatrix} \lambda & 0 & 0 & 1 \\ 1 & -\lambda & 0 & 0 \\ 0 & 1 & -\lambda & 0 \\ 0 & 0 & 1 & -\lambda \end{vmatrix} = 0$$

$$\lambda [\lambda(\lambda^2) - 1] = 0$$

$$\lambda^4 - 1 = 0$$

$$(\lambda^2 - 1)(\lambda^2 + 1) = 0 \Rightarrow (\lambda + 1)(\lambda - 1)(\lambda^2 + 1) = 0$$

$$\text{Eigenvalues} \Rightarrow 1, -1, i, -i$$

(ii) By Cayley Hamilton theorem

$$C^4 - I = 0 \Rightarrow C^4 = I$$

$$\Rightarrow C^{-1}C^4 = C^{-1}I \Rightarrow C^3 = C^{-1}$$

$$\{C^2\}^2 = \begin{bmatrix} 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \\ 0 & 1 & 0 & 0 \\ 0 & 0 & 1 & 0 \end{bmatrix} \begin{bmatrix} 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \\ 0 & 1 & 0 & 0 \\ 0 & 0 & 1 & 0 \end{bmatrix} = \begin{bmatrix} 0 & 0 & 1 & 0 \\ 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \\ 0 & 1 & 0 & 0 \end{bmatrix}$$

$$[C^3]^{-1} = [C]^{-1} = ([C]^T [C])^{-1} = \begin{bmatrix} 0 & 0 & 1 & 0 \\ 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \\ 0 & 1 & 0 & 0 \end{bmatrix} \begin{bmatrix} 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \\ 0 & 1 & 0 & 0 \\ 0 & 0 & 1 & 0 \end{bmatrix}$$

$$C^{-1} = \begin{bmatrix} 0 & 1 & 0 & 0 \\ 0 & 0 & 1 & 0 \\ 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \end{bmatrix}$$

$$[C^2]^{-1} = [C^{-1}]^2 = \begin{bmatrix} 0 & 1 & 0 & 0 \\ 0 & 0 & 1 & 0 \\ 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \end{bmatrix} \begin{bmatrix} 0 & 1 & 0 & 0 \\ 0 & 0 & 1 & 0 \\ 0 & 0 & 0 & 1 \\ 0 & 0 & 0 & 0 \end{bmatrix} = \begin{bmatrix} 0 & 0 & 0 & 0 \\ 0 & 0 & 0 & 1 \\ 1 & 0 & 0 & 0 \\ 0 & 1 & 0 & 0 \end{bmatrix}$$

$$|C| = 1 \times -1 \times 1 \times -1 = 1$$

$$|C+I| = \begin{vmatrix} 1 & 0 & 0 & 1 \\ 1 & 1 & 0 & 0 \\ 0 & 1 & 1 & 0 \\ 0 & 0 & 1 & 0 \end{vmatrix} = 1 \times \begin{vmatrix} 1 & 0 & 0 \\ 1 & 1 & 0 \\ 0 & 1 & 0 \end{vmatrix} - 1 \times \begin{vmatrix} 1 & 1 & 0 \\ 0 & 1 & 1 \\ 0 & 0 & 1 \end{vmatrix}$$

$$= 1 \times 1 - 1 \times 1 = 0$$

$$|C+2I| = \begin{vmatrix} 2 & 0 & 0 & 1 \\ 1 & 2 & 0 & 0 \\ 0 & 1 & 2 & 0 \\ 0 & 0 & 1 & 2 \end{vmatrix} = 2 \times \begin{vmatrix} 2 & 0 & 0 \\ 1 & 2 & 0 \\ 0 & 1 & 2 \end{vmatrix} - 1 \times \begin{vmatrix} 1 & 2 & 0 \\ 0 & 1 & 2 \\ 0 & 0 & 1 \end{vmatrix}$$

$$= 2 \times [2 \times 2] - 1 \times [1]$$

$$= 7$$

6(a)
(i)

Relaxation Oscillators are non sinusoidal oscillators
So active component ~~are~~ employed in these oscillator
works in non linear region while in
case of Sinusoidal oscillator active component
employed works in linear region and the
analysis is done in the frequency domain
for Sinusoidal Oscillators

In Nonlinear region for relaxation oscillator, it
is like charging and discharging of capacitors
while in linear region for Sinusoidal oscillator it
is like tank circuit ~~to~~ ~~provide~~ to provide
Sinusoidal output

(ii)

Here in given oscillator, gain $A = 1 + \frac{R_f}{R_i}$

feed back voltage $V_f = \beta V_o = \frac{Z_2}{Z_1 + Z_2} V_o$

$Z_2 \Rightarrow$ Parallel combination of R and C
 $Z_1 \Rightarrow$ Series combination of R and C

$$\beta = \frac{\frac{R \times \frac{1}{sC}}{R + \frac{1}{sC}}}{\frac{R \times \frac{1}{sC}}{R + \frac{1}{sC}} + R + \frac{1}{sC}} = \frac{\frac{R}{sCR + 1}}{\frac{R}{sCR + 1} + R + \frac{1}{sC}} = \frac{sCR}{sCR + sCR + 1 + Rsc[sCR + 1]}$$

$$\beta = \frac{SCR}{SR^2C^2 + 3SCR + 1} = \frac{RC}{SR^2C^2 + 3RC + \frac{1}{S}} = \frac{RC}{j\omega R^2C^2 + 3RC + \frac{1}{j\omega}}$$

for Sustained oscillation, phase of to satisfy Barkhausen Criteria ~~imaginary part~~ imaginary part of $[AB]$ should be zero

$$\therefore j\omega R^2C^2 - \frac{1}{\omega} = 0 \Rightarrow \omega^2 = \frac{1}{R^2C^2}$$

$$\boxed{\omega = \frac{1}{RC} \Rightarrow f = \frac{1}{2\pi RC}}$$

$$AB = \left(1 + \frac{R_f}{R_i}\right) \times \frac{RC}{3RC} = \left(1 + \frac{R_f}{R_i}\right) \times \frac{1}{3}$$

for $AB \geq 1$ (for Sustained oscillation)

$$\frac{1}{3} \left(1 + \frac{R_f}{R_i}\right) \geq 1 \Rightarrow \boxed{R_f \geq 2R_i}$$

necessary condition on R_f & R_i

At resonance, phase shift is Zero degree,

and by varying frequency below resonance then phase shift becomes positive and vice versa.

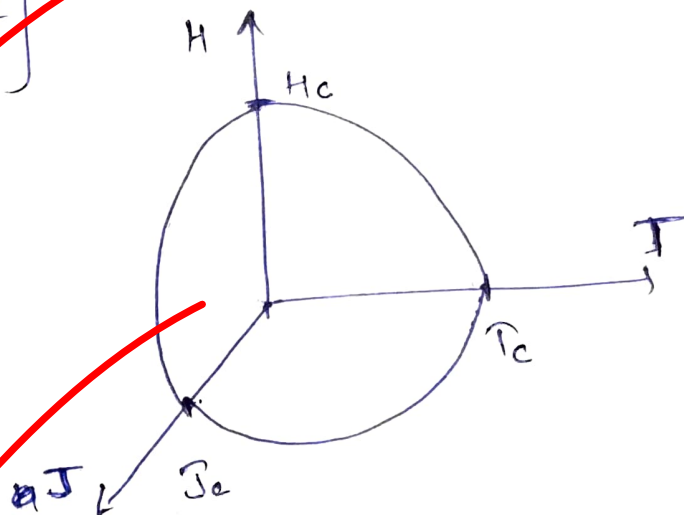
So, by varying applied frequency phase shift requirement is achieved.

Q. (b)
(i)

Superconductivity is defined by two features in a material, when a material possesses zero resistivity and perfect diamagnetism then this condition is known as superconductivity and the material is known as superconductor.

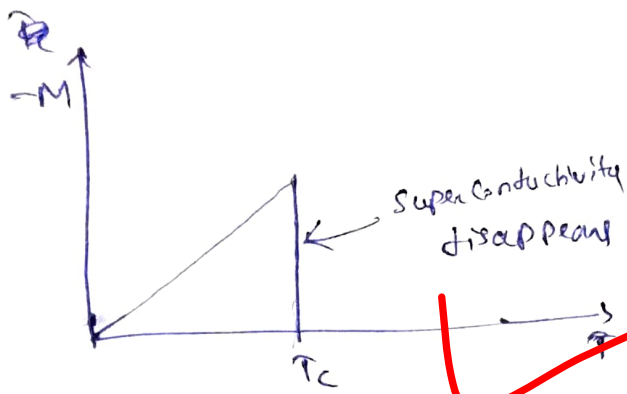
Critical temperature, T_c , critical field H_c , and critical current density J_c all are interrelated with each other by parabolic function.

$$H_c = H_0 \left[1 - \left(\frac{T}{T_c} \right)^2 \right]$$

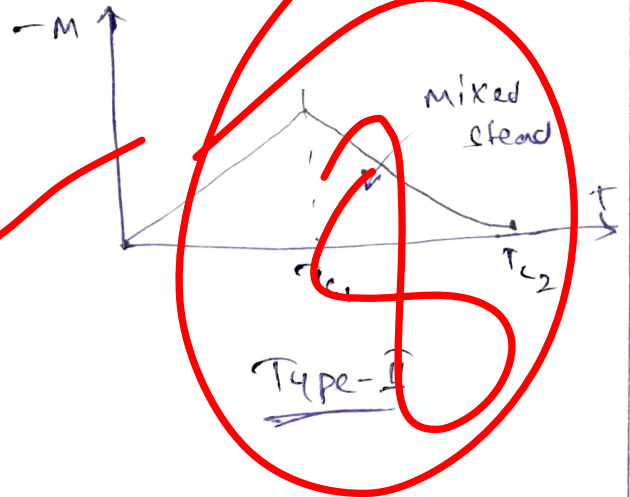


Type I Superconductors $\Rightarrow$ When the temperature (T) becomes greater than critical temperature (T_c) then superconductivity destroys abruptly, i.e., there is no mixed state in these superconductors. Eg $\Rightarrow$ Hg, Zn etc.

Type II Superconductors $\Rightarrow$ When there exists a mixed state between superconductivity and normal state then they are known as Type II superconductors. ~~There~~ These superconductivity destroys gradually. Eg $\Rightarrow$ NbTi, Nb₃Sn etc.



Type-I



Type-II

b)
(ii)

In a conductor,

$$\sigma = ne\mu = \frac{neV_d}{E}$$

$$[V_d = \mu E]$$

$\sigma \rightarrow$ conductivity

$\mu \rightarrow$ mobility

$V_d \rightarrow$ drift velocity

$$\frac{1}{1.54 \times 10^{-8}} = \frac{9.8 \times 10^{28} \times 1.6 \times 10^{-19} \times V_d}{1 \times 100}$$

$$V_d = 0.6997 \text{ m/s} \approx 0.7 \text{ m/s}$$

$$\text{mobility } (\mu) = \frac{V_d}{E} = \frac{0.6997}{100} = 6.997 \times 10^{-3} \text{ m}^2/\text{Vs}$$

$$\mu = 69.97 \text{ cm}^2/\text{Vsec.}$$

As,

$$V_d = \frac{e E \tau}{m}$$

$\tau \rightarrow$ Relaxation time.

$$0.6997 = \frac{1.6 \times 10^{-19} \times 100 \times \tau}{9.1 \times 10^{-31}}$$

$$\tau = 3.98 \times 10^{-14} \text{ sec.}$$

$$E_f = \frac{1}{2} m v_f^2$$

$$9.9 \times 10^{-19} \times 1.6 = \frac{1}{2} \times 9.1 \times 10^{-31} \times v_f^2$$

$$v_f = 1390.7 \text{ Km/sec}$$

6.(c)
(i)

RISC Architecture

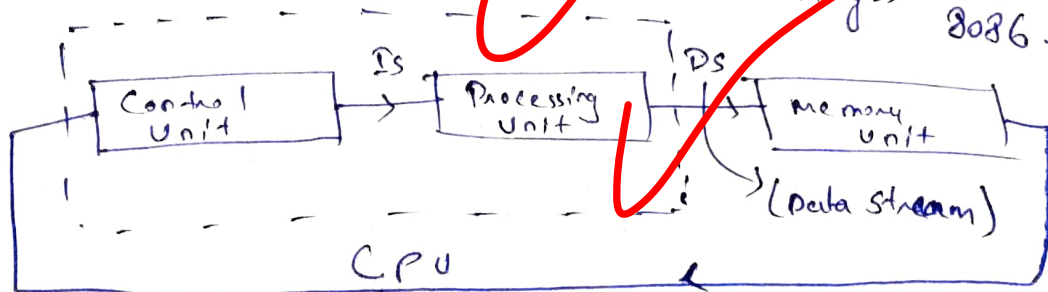
- Supports more Registers
- less addressing modes
- Fixed length instruction
- Supports successful pipelining
- Here CPI = 1
- It is a Super computer
- used in Real time applications
- Smaller instruction set
- eg → Motorola, ARM Processors

CISC Architecture

- less Supports less registers
- Supports less mode addressing mod
- Variable length instruction
- Unsuccessful pipelining
- Here CPI ≠ 1
- It is General purpose Computer
- used in personal applications
- longer instruction set
- Intel Processor.

(ii) Flynn's Classification,

(1) Single ~~in~~ instruction Single data Stream

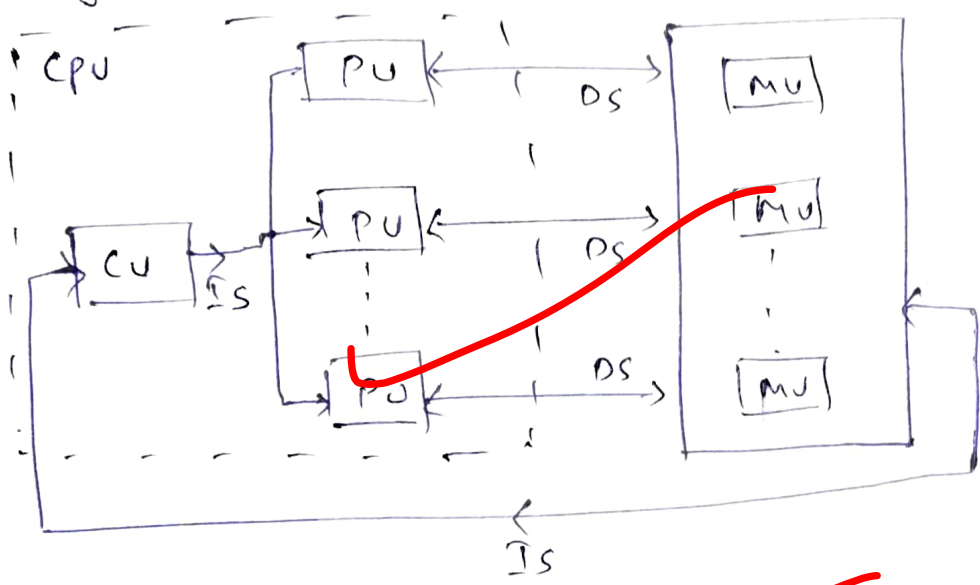


eg → 8085 µP
8086 µP

IS (instruction stream)

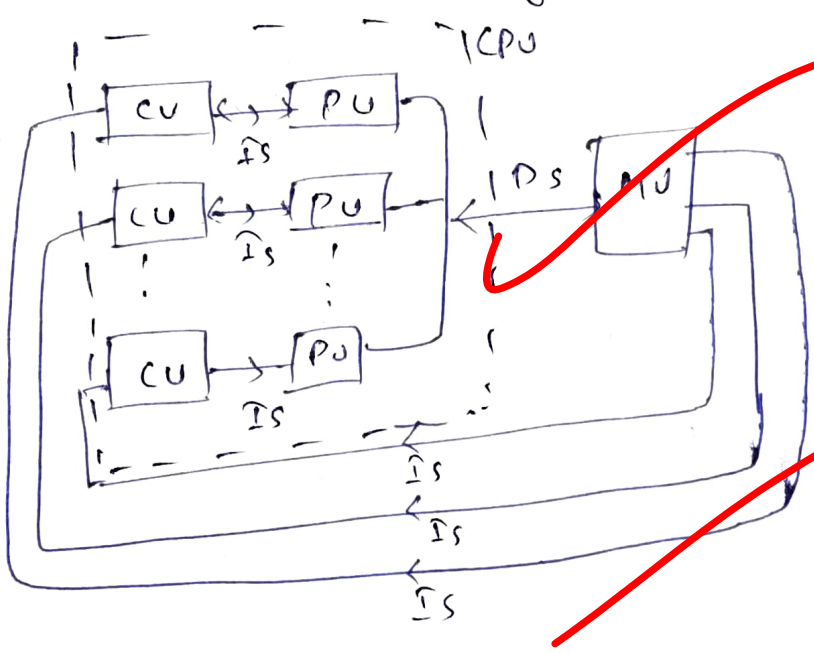
(I) Single instruction multiple data Stream

CU → Control unit
 PU → Processing unit
 MU → memory unit



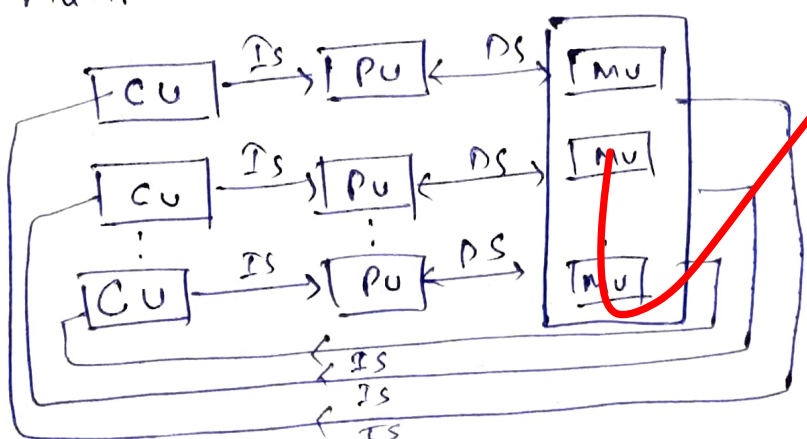
Implemented as a array Processor system design
 eg → Saturn Processor

(II) Multiple instruction Single data Stream



eg → It is not used practically as combining multiple processor but one is used at a time.

(IV) Multiple instruction multiple data Stream

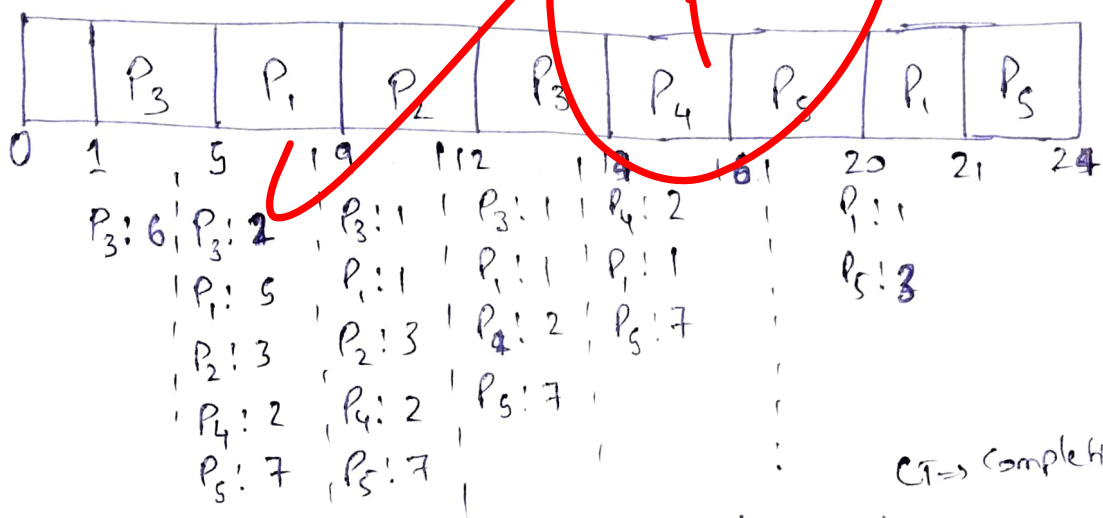


Implemented as multiprocessing system design.
 eg → Cray Processor
 Cyber Processor.

6. (c)
(iii)

Grant Chart

(Time Quantum = 4)



CT $\Rightarrow$ Completion time

	AT	BT	CT	TAT	WT
P ₁	2	5	21	19	14
P ₂	4	3	12	8	5
P ₃	1	6	14	13	7
P ₄	2	2	16	14	12
P ₅	3	7	24	21	14

~~TAT = CT - AT~~

~~WT = TAT - BT~~

~~Average TAT = $\frac{19 + 8 + 13 + 14 + 21}{5}$~~

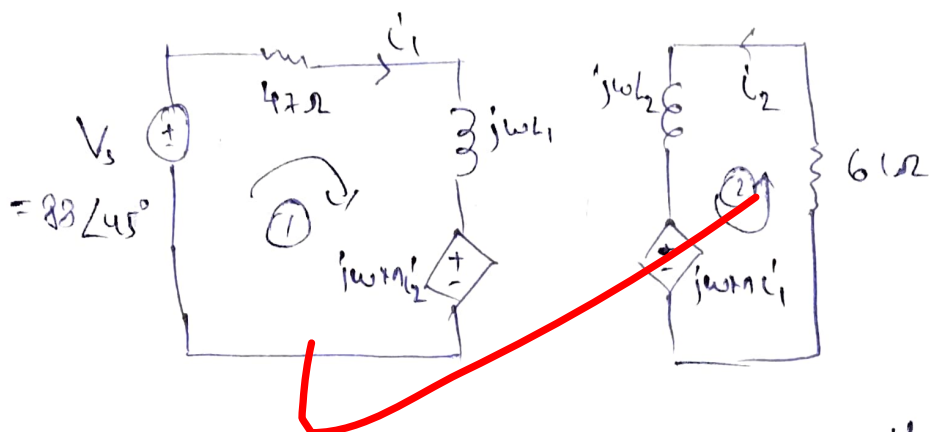
~~$(TAT)_{Avg.} = 15$~~

~~Average WT = $\frac{14 + 5 + 7 + 12 + 14}{5}$~~

~~$(WT)_{Avg.} = 10.4$~~

8. (a)
(i)

Converting the circuit in phasor domain



$L_1 = 18 \text{ H}, \quad L_2 = 27 \text{ H}, \quad M = 17 \text{ H}, \quad \omega = 6 \text{ rad/s}$

Applying KVL in loop ①

$$88 \angle 45^\circ = (47 + j6 \times 18) i_1 + j6 \times 17 i_2$$

$$88 \angle 45^\circ = (47 + j108) i_1 + j102 i_2 \quad \text{--- ①}$$

Applying KVL in loop ②

$$(61 + j6 \times 27) i_2 + j6 \times 17 i_1 = 0$$

$$(61 + j162) i_2 + j102 i_1 = 0 \quad \text{--- ②}$$

using ① & ②

$$88 \angle 45^\circ = \left[(47 + j108) + j102 \left(\frac{-j102}{61 + j162} \right) \right] i_1$$

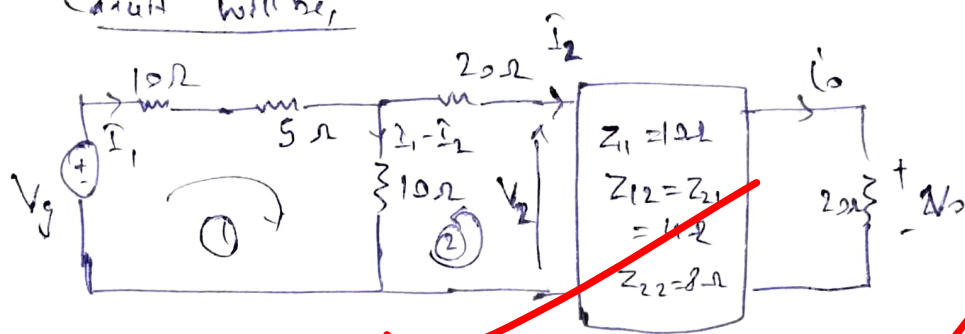
$$i_1 = 1.028 \angle 7.8^\circ \text{ A} = 1.028 \cos(6t + 7.8^\circ) \text{ A}$$

$$i_2 = \frac{-j102}{(61 + j162)} \times i_1 = \frac{-j102}{61 + j162} \times 1.028 \angle 7.8^\circ$$

$$i_2 = 0.6057 \angle -151.57^\circ = 0.6057 \cos[6t - 151.57^\circ] \text{ A}$$

8 (a)
(ii)

Circuit will be,



KVL in loop ①

$$V_g = (10+5) I_1 + 10(I_1 - I_2) \Rightarrow V_g = 25I_1 - 10I_2 \quad \text{--- (1)}$$

By Z parameters

$$V_2 = Z_{11} I_2 - I_0 Z_{12} \Rightarrow V_2 = 10I_2 - 4I_0 \quad \text{--- (2)}$$

$$V_0 = Z_{21} I_2 - I_0 Z_{22} \Rightarrow V_0 = 4I_2 - 8I_0 \quad \text{--- (3)}$$

Apply KVL in loop ②

$$V_2 = -20I_2 + 10(I_1 - I_2) = +10I_1 - 30I_2 \quad \text{--- (4)}$$

Using (4) in (2)

$$+10I_1 - 30I_2 = 10I_2 - 4I_0 \Rightarrow 40I_2 = 4I_0 + 10I_1$$

$$\Rightarrow 10I_2 = I_0 + 2.5I_1 \quad \text{--- (5)}$$

Using (5) in (3)

$$V_0 = \frac{4}{10}(I_0 + 2.5I_1) - 8I_0 = 0.4I_0 - 8I_0 + 2I_1$$

$$I_1 = -0.5V_0 + 7.6I_0 \quad \text{--- (6)}$$

Using (6) & (5) in (1)

$$V_g = 25[-0.5V_0 + 7.6I_0] - I_0 - 2.5(V_0 + 7.6I_0)$$

$$V_g = 22.5V_0 + 170I_0 \quad \text{--- (7)}$$

Resulting two port matrix is by comparing

$$V_1 = AV_2 + B\hat{I}_2 \Rightarrow V_g = 22.5V_o + 170\hat{I}_o$$

$$\hat{I}_1 = CV_2 + D\hat{I}_2 \Rightarrow \hat{I}_1 = V_o + 7.6\hat{I}_o$$

$$\begin{bmatrix} A & B \\ C & D \end{bmatrix} = \begin{bmatrix} 22.5 & 170 \\ 1 & 7.6 \end{bmatrix}$$

2. When $V_g = 10$,

$$10 = 22.5V_o + 170\hat{I}_o$$

$$\text{also } V_o = 20\hat{I}_o$$

$$10 = (22.5 \times 20 + 170)\hat{I}_o$$

$$\hat{I}_o = \frac{1}{62}$$

$$\text{Power delivered to load} = \hat{I}_o^2 \times R = \left(\frac{1}{62}\right)^2 \times 20$$

$$P = 5.203 \text{ mW}$$

$$P = 5.203 \text{ mW}$$

8. (b)
(i)

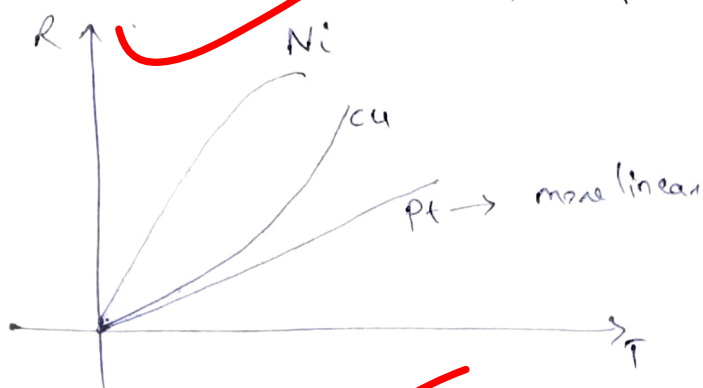
RTDs are the components having Positive temperature Coefficient of Resistance,

Eg $\Rightarrow$ Cu, Ni, Pt.

Here

$$R = R_0 [1 + \alpha \Delta T]$$

α $\rightarrow$ temperature Coefficient.



While, Thermistors have both positive and negative temperature Coefficient but negative temperature Coefficient thermistors are most practically used in temperature control of CRT's, like electrical heaters, microwaves etc.

$\rightarrow$ Used in BJT for temperature compensation.

$\rightarrow$ It has higher Sensitivity than RTD

$\rightarrow$ RTD are more linear than Thermistors

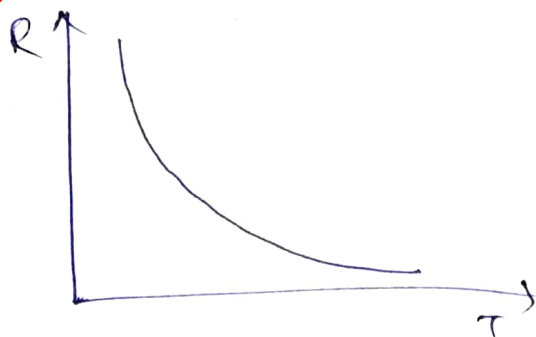
$\rightarrow$ RTDs have better Stability

$\rightarrow$ Thermistors are cheaper than RTDs

Now, For Negative temperature Coefficient thermistor

$$R = R_0 e^{B \left[\frac{1}{T} - \frac{1}{T_0} \right]}$$

B $\rightarrow$ temperature Coefficient



8(b)
(ii)

On some materials when force is applied then there is dynamic voltage is developed across the material. This is known as piezo electric effect and material which show this effect are known as piezoelectric materials,
eg = Quartz crystal, BaTiO_3 etc.

For the expression of voltage,

When ~~force~~ ^{Pressure} is applied, electric field is produced proportional to applied force.

$$\therefore E \propto P$$

$$\cancel{E} \propto \frac{V}{t} \propto P$$

$$E = \frac{V}{t}$$

$$\frac{V}{t} = gP$$

[$g \Rightarrow$ Voltage sensitivity]

$$V = g t P$$

[Here assumption is Pressure is dynamic not static]

in terms of force.

$$V = \frac{d}{\epsilon} \times t \times \frac{F}{A}$$

$$P = \frac{\text{Force}}{\text{Area}}$$

$$\text{and } g = \frac{d}{\epsilon}$$

$d =$ Charge sensitivity

Numerical

$$\text{Stress} = P = \frac{\text{Force}}{\text{Area}} = \frac{5}{5 \times 5 \times 10^{-6}} = 0.2 \times 10^6 \text{ N/m}^2$$

$$\text{modulus of elasticity} = \frac{\text{Stress}}{\text{Strain}}$$

$$12 \times 10^6 = \frac{0.2 \times 10^6}{\text{Strain}}$$

$$\Rightarrow \text{Strain} = 16.67 \times 10^{-3}$$

Charge is given by

$$Q = dF = 150 \times 10^{-12} \times 5$$

$$Q = 0.75 \text{ nC} = 750 \text{ pC}$$

Capacitance,

$$C = \frac{\epsilon A}{d} = \frac{8.85 \times 10^{-12} \times 12.5 \times 10^{-9} \times (5 \times 5 \times 10^{-6})}{1.25 \times 10^{-3}}$$

$$C = 250 \text{ pF}$$

Wiedemann Franz Law states that for Conductor material, its ratio of thermal conductivity to electrical conductivity is directly proportional to temperature,

$$\therefore, \frac{k}{\sigma} \propto T \Rightarrow \frac{k}{\sigma} = LT$$

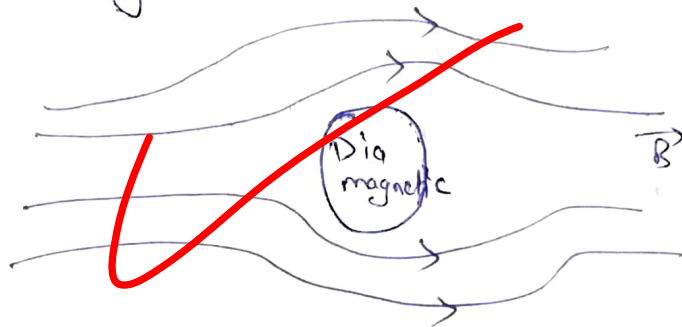
"L" is Lorenz no.

$$L = 2.44 \times 10^{-8} \text{ W}\Omega/\text{K}^2$$

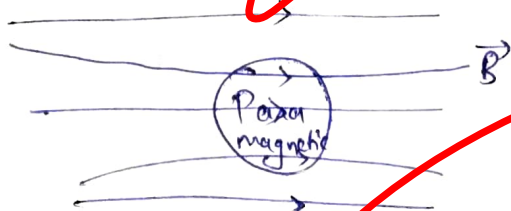
Thermal conductivity of stainless steel is reduced as it contains additive which can be thought as impurities which will increase thermal scattering due to difference in materials. Hence plain Carbon steel has greater thermal conductivity than for stainless steel.

8(a)
(ii)

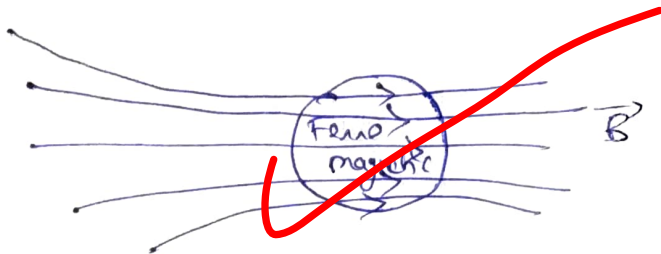
Diamagnetism $\Rightarrow$ When a material does not allow external magnetic field lines to pass through it then it is said to be diamagnetic material. It is due to full filled orbitals which contain both electron of opposite spin making the total magnetic moment zero.



Paramagnetism $\Rightarrow$ Some of the orbitals are half empty then due to only electron which is having a particular direction of electron spin making a magnetic moment non zero & will give rise to Paramagnetism. But consider the whole material due to randomness of magnetic moment it does not show spontaneous magnetization. Hence ~~weak~~ it allow some of ~~at~~ magnetic lines to pass through it



Ferromagnetism $\Rightarrow$ When there are many half filled orbitals hence there will be large magnetic moment which may give rise to spontaneous magnetization and it will attract ~~weak~~ magnetic field line to pass through it very strongly. This is Ferromagnetism



2

8. (e)
(11)

$$\rho = 8.90 \text{ g/cm}^3$$

$$Z = 58.71 \text{ g/mol}$$

$$\text{no. of atoms/cm}^3 = \frac{8.90}{58.71} \times 6.022 \times 10^{23} = 9.129 \times 10^{22}$$

$$\text{no. of atoms/m}^3 = 9.129 \times 10^{28}$$

$$\mu_{\text{Bohr magneton}} = \frac{e h}{4 \pi m} = \frac{1.6 \times 10^{-19} \times 6.626 \times 10^{-34}}{4 \pi \times 9.1 \times 10^{-31}} = 9.27 \times 10^{-24} \text{ Am}^2$$

$$\text{net } \mu_m = 0.6 \times 9.27 \times 10^{-24} = 5.562 \times 10^{-24} \text{ Am}^2$$

$$M = \text{no. of atoms/m}^3 \times \mu_m = 9.129 \times 10^{28} \times 5.562 \times 10^{-24} = 5.0775 \times 10^5 \text{ A/m}$$

Saturation magnetization $M = 5.0775 \times 10^5 \text{ A/m}$

Saturation flux density $B = \mu_0 M = 4 \pi \times 10^{-7} \times 5.0775 \times 10^5$

$B = 0.638 \text{ T}$